

Subject Index

A

- Absorption current, 47
- a-c breakdown strength, as current
 - function of rate of voltage application, 173
- a-c breakdown tests, 175–177
 - apparatus, 180–183
 - circuit schematic, 181
 - current sensing element, 182
 - high-voltage variable frequency test, 181
 - source transformer, 182
 - voltage increase rate, 181
- a-c bridge methods, high-voltage
 - power dissipation, 200
 - see also* Schering bridge; Transformer-ratio-arm bridge
- a-c/d-c breakdown process, 192
- a-c loss, 52
 - high voltage measurements, 157–216; *see also* Voltage breakdown tests
 - power expended, 58
- Activation energy, 328
- Active guard circuit, 121–122
- Active probe techniques, electrostatic charge measurement, 479–482
 - calibration, 480
 - capacitance, 480
 - electrostatic fieldmeter, 479
 - reliability, 481
 - surface charge density, 481
- Admittance meter, 94–95
- Aging
 - definition, 377
 - rate and temperature, 523
 - see also* Thermal degradation, aging and; Voltage aging
- Allylic chlorine, structure, 421
- Alumina, film specimen preparation, 197–198
- Analysis of variance, 522
- Anomalous breakdown process, 192
- ANOVA, 522
- Antioxidants, 326, 412
- Arcing
 - high density, salt mist, 271
 - patterns, 265
 - surface failure, 262–263
- Arrhenius equation, 328
- Arrhenius law, 252
- Arrhenius model, 522–524
- ASTM D 149, 168–171, 175, 177, 182
- ASTM D 150, 55, 85–86, 106, 108–110, 112–113, 116, 121, 248
- ASTM D 257, 4, 7–8, 12, 17–18, 22, 24, 27–28, 226–227
- ASTM D 374, 9–10
- ASTM D 495, 264–267
- ASTM D 618, 451
- ASTM D 651, 373
- ASTM D 669, 55
- ASTM D 1000, 240
- ASTM D 1289, 16
- ASTM D 1371, 11, 21
- ASTM D 1389, 171, 173
- ASTM D 1531, 115, 117

ASTM D 1711, 282
 ASTM D 2132, 287
 ASTM D 2149, 55
 ASTM D 2275, 254
 ASTM D 2302, 288
 ASTM D 2303, 288–291, 293–302
 ASTM D 2304, 290
 ASTM D 2307, 412
 ASTM D 2520, 55, 62, 129–133,
 135–137, 139
 ASTM D 2578, 223
 ASTM D 2679, 451, 482–483, 486
 ASTM D 3380, 55
 ASTM D 3426, 178–179, 184
 ASTM D 3509, 480
 ASTM D 3638, 282
 ASTM D 3686, 283
 ASTM D 3696, 284
 ASTM D 3755, 177–178, 183
 ASTM D 3909, 479
 ASTM E 104, 452
 Attenuation, resonant cavity meth-
 ods, 140
 Ayrton shunt, 21–22, 27–28

B

Beckman L-8 direct-indicating me-
 gohmmeter, 31
 Beckman-L-9 megohmmeter with
 digital readout, 32
 Bell-shaped curve. *See* Normal dis-
 tribution
 Benzene cell, 116
 Benzyl acetate, NMR spectrum, 369
 Bessel functions, 140
 Bow tie treeing, 406
 Breakdown
 impulse tests, 178–179
 probability, 526
 pulse tests, apparatus, 190–192
 specific field, 199
 Breakdown voltage. *See* Voltage
 breakdown

C

Cage effect, 324
 Calcium oxalate monohydrate,
 weight loss curve, 355
 Capacitance, 56
 accuracy of determination, 121
 apparent increase, 120
 bridge, Gen Rad Type 1621, 94
 defined, 375
 edge, 108, 110–111
 inter-electrode, 111
in vacuo, 118
 MKSA system, 537
 Schering bridge, 202–204, 207,
 209–210
 specimen, 86
 stray, 108–109
 susceptance variation method,
 103–106
 vacuum, 111–113
 Carbon deposits, 284–285
 Carbon dioxide, liberation, rate var-
 iation, 410
 Carbonization, 388
 Carbon monoxide, liberation, rate
 variation, 410
 Carbonyl, absorbance as function of
 irradiation energy, 402
 Chain depolymerization, 315–316
 Chain scission, 315, 321
 mechanical force, 335
 by ozone, 338
 polypropylene, 330–331
 radiolysis, 333
 Characteristic breakdown stress,
 502
 Characteristic time-to-failure, 503
 Charged particle bombardment,
 role in discharge degrada-
 tion, 400–404
 Charge effect hypothesis, 173–174
 Charging current, 32–33
 Chemical degradation, polymers,
 336–338

- Chemical shift, 368–369
 Chi-square distribution, 509–510
 Cleaning, plastic specimens, 11–12
 Closed cavity system, 135
 Coatings, non-linear resistance characteristic with voltage, 260
 Coaxial electrode system, direct-current conductivity, 7
 Coaxial line method, 54
 Coaxial resonator system, 135
 Cockroft-Walton heavy ion accelerator, 402
 Cole-Cole plot, polymers, 377
 Colloidal graphite electrodes, 15–16
 Comparative tests, 513, 516–521
 difference between population means divided by standard deviation, 517–518
 Log-Normal distribution, 517
 Normal distribution, 513, 516–517
 randomization, 519–521
 Weibull distribution, 517
 Comparative tracking index, 283–284
 Complex admittance, 80–81
 Conduction current, variation with time, 246
 Conductivity
 surface, 242–243
 see also d-c conductivity
 Confidence bounds, 508–513
 95% bounds, Weibull distribution, 514, 516
 80% confidence intervals, Weibull distribution, 515, 519
 mean, 508
 Normal standard deviation, 509
 t-values, 508
 upper and lower probability points of chi-square distribution, 510
 V-values, Weibull distribution, 511–512
 W-values, Weibull distribution, 512
 Contact hypothesis, 442–443
 Contact potential, 445–446, 469
 equation, 446
 series, 442–444
 Corona
 degradation, polymers, 339
 erosion, model, 411
 life, effect of elongation, 396
 surface, 221, 235–255, 260
 Corona discharge, 162, 164–165, 170
 charged particle bombardment, 400
 degradation of polymer surface, 394–395
 electron role, 404
 frequency acceleration of discharge degradation, 406–407
 microvoids, 370
 modelling discharge degradation, 383–385
 ozone role in discharge degradation, 395–400
 processes and constituents of discharge degradation, 382–383
 simulation, 384
 see also Partial discharges
 Corona-mechanical stress cracking, 394
 Corona-stress cracking, 395
 Corona test cell, 388
 Corrosion liability factor, 240
 Coulomb's law, 533, 538
 Cr-Au counterelectrodes, 13–14
 Creepage, distance versus operating voltage, 269
 Crosslinking, 314, 325
 mathematical descriptions, 332
 by ozone, 338
 polyethylene, 334
 radiation, correlation with heats of polymerization, 333

Cu(Cu₂O)-polymer, total pressure changes as function of exposure time, 423, 425
 Cumulative density function, 498

D

Dacron, surface resistivity, 232–233

Dakin's equation, 408

d-c breakdown test, 177–178
 apparatus, 183–184
 bipolar supply, 184
 circuit with polarity reversing switch, 184

d-c conductivity, 3–49
 absorption current, 47
 Ayrton shunt, 21–22
 coaxial electrode system, 7
 comparison method, 27–28
 decrease in current with time, 18
 defined, 5
 direct reading instruments, 31–33
 earth resistance measurements, 46–49
 elastomer, 10–11
 electrification, 17–18
 electrode systems and specimens, 6–17

electrometer arrangement, 21
 galvanometer method, 21–23
 high voltage source, 47
 humidity effect, 17
 inorganic dielectric film specimens, 14

interfacial polarization, 17
 measurement fundamentals, 19–20
 Megger circuit, 45–46
 paper specimens, 10
 resistance measurements for specialized applications, 45–47
 resistive voltage divider network, 19

space charge, 17
 specimen charging effects, 47
 specimen film thickness, 15
 surface cleanliness, 11–12
 tests at elevated temperatures, 16
 thermally stimulated current measurements. *See* Thermally stimulated current measurements
 tin foil electrodes, 12
 units, 5
 voltage rate-of-change method, 25–27
 voltage ratio, 19
 voltmeter-ammeter method, with D-C amplification, 23–24
 voltmeter input resistance, 20
 volume, 6–7
 water-electrode-bath system, 7
 Wheatstone bridge method, 28–30

d-c integrator, 464–467

Dehydrochlorination, polyvinyl chloride, 419–420

Density, polymer degradation, 374

Dendritic structures. *See* Trees

Depolymerization, arcing, 262–263

Depropagation, 317–318

Deproportion reaction, 324

Detroit Edison Tracking Test, 282

Dielectric constant. *See* Permittivity

Dielectric displacement, 535

Dielectric failure, defined, 176

Dielectric material

capacitance, 56

conductivity, definition, 57

dissipation factor. *See* Dissipation factor

as-distributed parameter specimens, 59–64

impedance, 97

intrinsic breakdown strength, 160

low alternating-current loss, 52

- lumped parameter specimens, 55–59
 - parallel equivalent circuit, 56
 - phasor diagram, 56
 - total current density vector, 57
 - transverse electromagnetic wave, 59–60
 - tubular specimen, 171
 - voltage distribution across, 249
 - Differential scanning calorimetry, 353, 411
 - Differential thermal analysis, 350–353, 411–412
 - analyzer, 351
 - endotherm, 352
 - exotherm, 352
 - variation in baseline with specific heat of sample, 352
 - Dilute solution viscometry, polymer degradation, 345–347
 - Dipole orientation, 36–37
 - Direct voltage breakdowns, 177
 - Dissipation factor, 57–59, 62, 77, 84, 86, 93
 - apparent increase, 120
 - change with different stabilizer concentrations, 379
 - change with exposure to water, 378
 - confocal optical resonator, 145
 - fluid displacement cell, 118
 - free space methods, 143
 - as function of IR absorbance for polypropylene, 383
 - Michelson interferometer, 150
 - micrometer-electrode system, 115
 - open cavity resonator, 141
 - optical methods, using laser source, 152
 - parallel *T*-network, 98–99
 - polyethylene
 - discharge effect, 399
 - ozone effect, 400
 - polymers, 375
 - Q*-meter method, 101
 - resonant cavity methods, 139
 - Schering bridge, 202, 204, 206–207, 209–210
 - semi-confocal optical cavity resonator, 145–147
 - silicone fluids, 117
 - susceptance variation method, 107
 - transformer-ratio-arm bridge, 212–213, 215
 - transmission line method, 133
 - Distributed network, lumped circuit equivalent, 259
 - Dry arc resistance, 263–268
 - arcing patterns, 265
 - comparison of rod and strip electrodes, 266
 - high current arc ignition test, 267
 - high-voltage, low-current tracking test, 267
 - stainless-steel strip electrodes, 265
 - tungsten rode electrodes, 264
 - Du Pont dynamic mechanical analyzer, 356
 - Dynamic electrical behavior, polymer degradation, 374–377
 - Dynamic mechanical analysis, polymer degradation, 354–356
- E**
- Earth resistivity measurements, 48
 - Edge correction, 110
 - n*-Eicosane, degradation products, 384
 - Elastomer, thickness of specimen, 10–11
 - Electrical behavior, dynamic, polymer degradation, 374–377
 - Electrical tree, 338–339
 - Electrical units, systems of units, 531–533

- Electric breakdown, model, 384–385
- Electric field
- electrostatic fieldmeter, 471
 - Gaussian CGS system, 534
 - gradient, 446
 - relationship with surface charge density, 447
 - vectors, 60
- Electrode
- considerations in dielectric strength measurement, 174
 - contact pressure, 12
 - counter guard, mask design, 119
 - direct-current conductivity, 6–17
 - disk or circular metallic, 7–8
 - edge effects, 10
 - effective area, 8
 - electric field enhancement as function of radial distance of HV cylindrical electrode, 167
 - equipotential lines between two electrodes, 166
 - flux line
 - distribution between, 109
 - fringing, 8
 - foil, 171
 - geometries that influence a-c voltage distribution, 249–250
 - gold-evaporated, 38–39
 - guarded parallel-plane, flux line distribution, 110
 - hemispherical, 171
 - high conductivity silver paint, 12–13
 - large slab dielectric specimens, 15–16
 - metallic film, 13
 - non-parallelism, 9
 - penetration or reduction of thickness, 10
 - presser foot pressures, 9–10
 - selection of materials, 6
 - spherical, 162–163
 - stainless-steel strip, 265
 - tests at elevated temperatures, 16
 - thickness determination, 15
 - tin foil, 12
 - tungsten rod, 264
 - volume conductivity, 6–7
 - see also* Lumped parameter measurements, electrode systems
- Electrode system
- composite, 169–170
 - equal diameter, 169
 - intrinsic breakdown strength, 165–172
 - breakdown voltage, 165–166
 - corona discharges, 165, 170
 - embedded electrodes, 170
 - heavy wall insulating materials, 171–172
 - laminated materials, 171–172
 - pre-breakdown mechanisms, 169
 - sheet and roll form materials, 171–173
 - tubular dielectric specimen, 171
 - McKeown, 164
 - measurement for dielectric specimens, 119–120
 - recessed, 160
 - spherical HV electrode, 162–164
 - unequal diameter, 168
- Electrolytic corrosion, surface, 240
- Electromagnetic wave propagation, modes in waveguides, 61–62
- Electrometer, 196, 453–454
- drift correction procedure, 486
- Electron
- role in discharge degradation, 404
 - total density, 34
- Electron spin resonance, polymer degradation, 364–367
- electron energy splitting, 366
 - energy difference, 364

- microwave radiation frequency, 365
- spectra, 365
- spectrometer, 367
- trees, 405
- triplet absorption signal, 366
- Electrophotography, 469
- Electroscope method, 472-473
- Electrostatic charge
 - amount of charge transferred by contact charging, 448
 - applications, 441
 - charge generation due to sliding contact, 449
 - contact hypothesis, 442-443
 - contact potential, 445-446
 - series, 442-444
 - electric field gradient, 446
 - finite time constant, 445
 - measurements
 - d-c integrator, 464-467
 - electrometers, 453-454
 - electrostatic modulators, 460-463
 - electrostatic voltage follower, 456-458
 - feedback electrostatic fieldmeter, 458-460
 - field intensity methods, 473-482
 - field mill electrostatic fieldmeters, 452, 454-456
 - methods, 472-473
 - oscillator, 462
 - phase-sensitive demodulator, 462, 464
 - probe transducer characteristics, 467, 469-470
 - radioactive fieldmeters, 454
 - reliability, 481
 - signal amplifier, 462
 - slow drift, 453-454
 - test specimens, 450-452
 - problems created by, 440
 - proportionality constant, 445
 - relationship between surface charge density and electric field, 447
 - surface charge
 - decay half life and relative humidity, 451
 - density as function of applied pressure, 448-449
 - density values, 447-448
 - distribution, 444
 - facing grounded metallic plane, 447
 - necessary for development of hazardous sparks, 449
 - thermodynamic equilibrium, 445
 - topography of materials, 448
 - triboelectric series, 441-442
 - triboelectrification, 441
 - tunnelling, 444
- Electrostatic fieldmeter
 - with active probe, 479
 - notes, 471-472
- Electrostatic modulators, 460-463
- Electrostatic voltage follower, 456-458
 - circuit diagram, 457
 - d-c integrator, 464-467
 - drift measurements, 469
 - electrostatic modulator, 460-463
 - notes, 470
 - oscillator, 462
 - phase-sensitive demodulator, 462, 464
 - probe-to-specimen surface spacing, 469
 - probe transducer, 467, 469-470
 - signal amplified, 462
- Endotherm, 352
- Epoxy
 - evaluation of gaseous products, 411
 - flashover values, 282
 - thermal degradation, 421-422

- Epoxy-mica composite
 - degradation mechanism, 422
 - weight changes, exposure to surface discharges, 385
 - Equivalence hypothesis, 526–527
 - Erosion, partial discharges, 385–388
 - polyethylene, 385–387
 - proportionality constants, 387
 - weight changes, 385
 - Erosion drop test, 282–286
 - comparative tracking index, 283–284
 - drops to cause propagation of carbon path, 285
 - drops to initiate carbon deposits versus voltage, 285
 - electrode arrangement, 283
 - proof tracing index, 284
 - Erosion tests, 286–309
 - cumulative current, 302–309
 - average leakage current versus time, 304
 - charge transfer versus time in salt fog, 305
 - computerized data acquisition, 304
 - electrode assembly, 303
 - erosion versus charge transfer, 303
 - failure mechanisms, salt fog test, 306–307
 - integrated scintillation current, 306, 308
 - surge currents, 308
 - differential wet tracking resistance, 288
 - dust-and-fog tracking and erosion resistance, 287–288
 - eroded volume, 295, 298
 - versus time, 295
 - versus voltage, 294
 - erosion depth, 295, 297
 - versus time, 294
 - versus voltage, 293
 - liquid-contaminant, inclined-plane tracking and erosion test, 288
 - severe ambient conditions, 288–289
 - specimen and electrode assembly, 289
 - tracking-endurance test, 287
 - track-resistant materials, 291
 - types, 286–287
 - see also* Erosion drop test; Tracking
 - Ester formation, polyethylene, 418
 - Ethylene propylene rubber, erosion versus charge transfer, 302–303
 - Exotherm, 352
 - Experimental designs, 521–522
- F**
- Fabry-Pérot interferometer, 54, 143
 - Factorial design, 521–522
 - Faraday cage methods, 472, 482–486
 - block diagram, 482
 - cage design, 483
 - capacitance, 485
 - drift correction procedure, 486
 - electrodes, 483
 - grid system, 483–484
 - Maxwell's equation, 484
 - particle charge decay, 484
 - schematic, 483
 - voltage between electrodes, 485
 - Feedback electrostatic fieldmeter, 458–460
 - Field intensity methods
 - active probe techniques, 479–482
 - passive probe techniques, 473–479
 - Field mill electrostatic fieldmeters, 452, 454–456

- Finite time constant, 445
- Flashover
 epoxy strips, 282
 exposed insulators in deserts, 281
 high density, salt mist, 271
 wet contaminated surfaces, 269–280
 apparatus, 278
 contaminated insulation after long-term outdoor exposure to voltage, 279–282
 minimum, 275, 278
 salt fog chamber, 282
 salt fog versus salt content, 279
 weathered epoxy strips, 280, 282
- Flashover voltage
 dependence on dielectric constant, 250
 effect of salt concentration and temperature, 275
 effects of electrode geometry, 250–251
 as function of pressure and electrode spacing, 252
 limiting, versus heat of formation, 274
 minimum, change versus thickness of ice, 281
 particles on insulating surfaces, 261
 polystyrene, 279
 post insulators, 261
 silica glass, 277
 Teflon, 277
- Fluid displacement, 115–118
- Force vector, 533
- Fourier Transform IR, 363
- Four-terminal method, earth resistivity measurement, 49
- Free space methods, 142
- Frequency acceleration, discharge degradation, 406–407
- Frequency response analyzer scheme, 80–81
- Fringing effects, 108–109
- Fungus growth
 effect on electrical characteristics of insulating materials, 236
 surface failure measurements, 234–240
- G**
- Galvanometer method, 21–23
 comparison method, 27–28
- Gas chromatography
n-eicosane degradation products, 384
 gas mixtures, 390, 392
 polymer degradation, 356–358
 polypropylene, 392
- Gas chromatography/mass spectroscopy
 polymer degradation, 361
 pyrolysis products, 409
- Gas evolution, partial discharges, 388–393
 discharge degradation products, 392
 gas chromatography, 390, 392
 gas product, polymers exposed to arcing in inert atmosphere, 391
 hydrogen evolution rate in closed cell, 389
 proportionality constant dependence on total discharge energy, 389–390
 SF₆ exposed to arc discharge, 391
- Gas-insulated spacer cable, 262
- Gas-liquid chromatography, 357
- Gas-solid chromatography, 357
- Gaussian CGS system, 532–536
 conversion factors with SI system, 541–542
 dielectric displacement, 535

Gaussian CGS system (*continued*)
 dimensions and units, 536
 electric field, 534
 electric flux density vectors, 535
 force vector, 533
 Maxwell electromagnetic field equations, 535
 relationship with MKSA system, 537–538

Gaussian distribution. *See* Normal distribution

Gel permeation chromatography, polymer degradation, 347–350
 bimodal curve, 348
 chromatography, 348–349
 high temperature, 349–350
 polyethylene, 413–415

Glass composition, influence on surface resistivity, 243–244

Glass-polymer, total pressure changes as function of exposure time, 423, 425

Glass transition temperature
 definition, 350
 effect of structural factors, 351

Glynne bridge, 212

Guard electrodes, 119

Guard gap correction, 112

H

Hartshorn and Ward resonance technique, 54

Heaviside-Lorentz system. *See* Gaussian CGS system

Heavy wall insulating materials, 171–172

Hetratetracontane, thermal-oxidative degradation, 416–417

High Current Arc Ignition Test, 267

High performance liquid chromatography, polymer degradation, 361–362

High Voltage Arc Tracking Rate Index Test, 267

Histogram, 492

Humidity
 effects on direct-current conductivity measurements, 17
 surface conductivity and, 444
see also Relative humidity

Hydrogen, evolution rate in closed cell, 389

Hydrogen peroxide, deactivation, 326–327

Hydroperoxides, 323

I

IEC Publication 93, 4

IEC Publication 112, 282–286

IEC Publication 243, 167–168, 170–172, 176, 178, 184

IEC Publication 250, 55

IEC Publication 377, 55, 62–63, 134–135, 138–141, 146

IEC Publication 426, 240–241

IEC Publication 587, 288–289, 299

IEEE Standard 101–1972, 524

Impedance
 dielectric materials, 97
 load, 130–131
 specimen-air interface, 130

Impulse breakdown tests, 178–179

Impulse generators, 184–190
 coaxial line impedance, 188
 multi-stage, 185, 189
 oscillographic method, 187
 peak value of voltage wave, 188
 single-stage, 186
 small capacitance specimens, 189–190
 sphere gaps, 187
 stray inductance, 186–187
 virtual front time, 185, 187, 189–190
 voltage waveform across specimen, 187

Impulse strength, 173–174
 Index of refraction, 61
 confocal optical resonator, 144–145
 Michelson interferometer, 149
 optical methods, using laser source, 151
 Infrared spectroscopy
 absorption as function of charge, 401
 high resolution, oxidized groups on polymers, 398
 polyethylene, 415
 polymer degradation, 362–364
 pyrolyzing silica-polytetrafluoroethylene, 411
 Inorganic dielectric films
 breakdown strength, 196
 thickness, 14
 Insulation
 Dakin's equation for life of, 408
 evaluation. *See* Statistical methods for evaluation
 leakage current, 45
 resistance, 4, 20, 26–27, 32–33, 45
 defined, 225
 as function of time, 25
 measurement, 225–226
 parallel equivalent, 22
 surfaces, charging, 253
 Insulator post, 261
 Interfacial failure, 221
 Interfacial polarization, 17
 Interference optics, 142
 Intermolecular hydrogen abstraction, polyethylene, 415
 Inverse power model, 524–526
 Isoprobe electrostatic voltmeter, 462–464, 470

K

Karl Fischer reagent, 372
 Kirchoff's equation, 19
 Kirchoff's edge correction, 106

L

Lambert-Beer law, 330
 Laminated materials, 171–172
 Leakage current, 32–33, 45
 polytetrafluoroethylene, 242–244, 246
 versus time, PMMA, 304
 versus voltage, 272
 LED/photoconductor high voltage
 d-c integrator-amplifier, 466–468
 Lichtenberg figures, 255, 472
 Life prediction techniques, 522–527
 Arrhenius model, 522–524
 equivalence hypothesis, 526–527
 inverse power model, 524–526
 Life testing, frequency acceleration, 406
 Light scattering, 343–345
 Liquid chromatography, high performance, polymer degradation, 361–362
 Liquid-liquid chromatography, 361
 Liquid-solid chromatography, 362
 Log-Normal distribution, 492–493, 499–501
 commercial probability paper, 501
 comparative tests, 517
 confidence bounds, 510–511
 logarithmic mean, 500
 logarithmic standard deviation, 500
 median, 500
 parameter distribution, 500–501
 Long chain branching, polyethylene, 416
 Loss tangent. *See* Dissipation factor
 Lumped parameter measurements,
 electrode systems, 108–122
 completely shielded and guarded
 electrode system, 111–112
 dissipation factor, 115
 edge capacitance, 108, 110–111

- Lumped parameter measurements, electrode systems (*continued*)
- equivalent circuit of two-terminal cell, 109
 - fluid displacement, 115–118
 - flux line distribution, 109–110
 - fringing effects, 108–109
 - guard gap correction, 112
 - inter-electrode capacitance, 111
 - micrometer-electrode system, 114
 - ratio of electrode thickness to guard gap as function of parameter A , 112–113
 - silicone fluids, 117
 - vacuum capacitance, 112–113
- M**
- Magnetic field vectors, 60
- Mark-Houwink-Sakurada constants, 348
- Mark-Houwink-Sakurada equation, 340, 347
- Marx generator, 185, 193
- Mass spectrometry, polymer degradation, 359–360
- polyvinyl chloride pyrolysis products, 419
- Matching coefficient, 146–147
- Maxwell electromagnetic field equations, 535, 538
- Maxwell equation, 60, 484
- McKeown specimen-electrode system, 164
- Mean, 494–495
- logarithmic, 500
- Mechanical analysis, dynamic, polymer degradation, 354–356
- Mechanochemical degradation, polymers, 335–336
- Median, 500
- Megger circuit, 45–47
- Membrane osmometry, 341–343
- Metallic evaporated films, 163
- Metallic evaporated films, 163
- 3-Methyl-4-phenyl-2-butanone, 359–360
- Michelson interferometer, 147–150
- Micrometer-electrode system, 114
- Microprobe, 478–479
- Microscopy, polymer degradation, 370–372
- Microvoids, impregnation, 405
- MKSA system, 532, 536–539
- capacitance, 537
 - Coulomb's law, 538
 - dimensions and units, 539
 - farad, 537
 - force, 537
 - Maxwell's electromagnetic field equations, 538
 - permittivity, 536–537
 - proportionality constant, 536
 - power loss relationship, 537
 - relationship with Gaussian CGS system, 537–538
- Modulus, 354–355
- Molecular weight methods, polymer degradation, 340–350
- dilute solution viscometry, 345–347
 - gel permeation chromatography, 347–350
 - number-average molecular weight, 341–343
 - weight-average molecular weight, 343–345
- Multiple internal reflectance, 363
- polyethylene, 400–401
- Mylar, breakdown strength, 194
- N**
- Nested design, 522
- Newton's second law of motion, 533
- Nitrogen dioxide, polymer degradation, 337
- Normal distribution, 492–499
- commercial probability paper, 497

- comparative tests, 513, 516–517
- cumulative density function, 498
- equation, 494
- mean, 494–495
- parameter determination, 496–498
- probabilities, 498–499
- probability density function, 498
- standard deviation, 495, 509
- variance, 495–496
- Norrish reactions, 329
- NRC/Guideline current comparator bridge, 214–215
- Nuclear magnetic resonance, polymer degradation, 367–370
 - chemical shift values, 368–369
 - energy difference, 368
 - radiation frequency, 368
 - triplet signal, 370
 - vicinal protons, 370
- Number-average molecular weight, polymer degradation, 341–343
- Nyquist frequency, 67

O

- Ohm's Law, 4
- Oil-modified, phenolic varnish coated on solid glass surface resistivity, 239
- Open cavity resonator, 135, 139–140
- Open resonator method, 54
- Optical cavity resonators, 143
- Optical methods, 142–152
 - confocal optical resonator, 143–145
 - dissipation factor, 152
 - free space methods, 142
 - index of refraction, 151
 - interference optics, 142
 - matching coefficient, 146–147
 - Michelson interferometer, 147–150

- optical cavity resonators, 143
- quasi-optical measurement techniques, 142–143
- semi-confocal optical cavity resonator, 145–147
- submillimeter wave methods, 147
- using laser sources, 150–152
- Optical resonator system, 135
- Oscillator, 462
- Osmotic pressure, 343
- Oxalic acid, 393, 397
- Oxidative degradation, polymers, 322–327
 - antioxidants, 326
 - cage effect, 324
 - crosslinking, 325
 - disproportion reaction, 324
 - hydroperoxides, 322–323
 - kinetics, 325
 - metal catalysts, 325–327
 - oxygen uptake rate, 325
 - polymer radical formation, 322
 - propagation reactions, 323
- Oxidized silicon slice substrate, with evaporated counter-electrodes, 13–14
- Oxygen, absorption, rate variation, 410
- Ozone
 - polymer degradation, 338
 - role in discharge degradation, 395–400

P

- Paper-phenolic laminate
 - effect of electrode geometry on flashover voltage, 250–251
 - surface resistivity, 231–232
- Parallel *T*-network, 98–99
- Partial discharges
 - chemical degradation in treeing, 404–406
 - critical discharge level, 381
 - detection, 380–381

- Partial discharges (*continued*)
- erosion by, 385–388
 - gas evolution, 388–393
 - magnitude and repetition rate, 381
 - modelling discharge degradation, 383–385
 - processes and constituents of discharge degradation, 382–383
 - voltage at which void will break down, 380
 - weight changes and exposure to surface discharges, 385
 - see also* Corona discharge
- Paschen minimum, 251
- Paschen's law, 405
- Passive probe techniques, electrostatic charge measurement, 473–479
- capacitance, 474–475
 - connection diagram, 476
 - Devins and Reynolds design, 474
 - equivalent circuit, 474–475
 - high resolution, 477
 - microprobe, 478–479
 - surface charge density, 475–476
- Peroxide curing, polyethylene, 418
- Permeability, permittivity and, 531–532
- Permittivity, 52–53, 57, 133, 141, 150
- complex, 125, 375
 - definition, 56
 - dependence of flashover voltage, 250
 - fluid displacement cell, 116
 - free space methods, 142
 - in vacuo*, 60
 - measurement methods
 - active guard circuit, 121–122
 - admittance meter, 94–95
 - admittance of specimen, 80–81
 - electrode systems for lumped parameter measurements, 108–122
 - frequency response analyzer scheme, 80–81
 - high frequency, 122–152
 - intermediate frequencies, 81–98
 - low frequency, 65–81
 - Nyquist frequency, 67
 - optical methods. *See* Optical methods
 - parallel *T*, 98–99
 - Q-meter method, 99–102
 - R-C bridge measurement techniques, 81–82
 - resonant cavity methods. *See* Resonant cavity methods
 - RLC meter, 96–98
 - Schering bridge. *See* Schering bridge
 - square voltage pulse, 72–73
 - step response system. *See* Step response system
 - step voltage, 122–123
 - susceptance variation method, 102–108
 - Thompson-Harris low frequency bridge, 75–79
 - time domain methods, 122–126; *see also* Time domain reflectometry
 - total reflectance, 127
 - upper and high frequency, 98–108
 - various frequency ranges, 64
 - voltage step, 65
 - see also* Lumped parameter measurements, electrode systems
- MKSA system, 536–537
- optical methods, using laser source, 151
- optical or high frequency value, 124
- permeability and, 531–532
- polyethylene, 117
- discharge effect, 399

- ozone effect, 400
- polymers, 375
- real and imaginary values, 61, 159
- relative
 - applied voltage step, 65–68
 - complex, 60
 - error analysis, 71–72
 - as function of frequencies, 71
 - real, 139, 141
- resonant cavity methods, 139
- semi-confocal optical cavity resonator, 146
- static value, 124
- systems of units, 531
- Phase constant, resonant cavity methods, 140
- Phase distance, confocal optical resonator, 144–145
- Phase-sensitive demodulator, 462, 464
- Phase shift, Michelson interferometer, 149
- Photodissociation, rate, 328
- Photolysis, polymers, 328–333
 - activation energy, 328
 - mathematical descriptions, 332–333
 - Norrish reactions, 329
 - polyethylene, 329–330
 - polypropylene, 330–331
 - polyvinyl chloride, 331–332
- Photostimulated detrapping current techniques, 41
- Physical constants, values, 544
- Plastic insulated wire, surface resistance, 236–237
- Poleck-type universal capacitance and $\tan \delta$ bridge, 208–210
- Polyamide, dissipation factor change with exposure to water, 378
- Polydispersity, definition, 341
- Polyester glass-mat laminate, inclined plane tracking test, 299
- Polyethylene
 - behavior in oxygen-containing atmosphere, 389–390
 - bimodal GPC curve, heat-aged, 348
 - change in molecular weight distribution with heat, 413–415
 - dielectric breakdown at elevated temperatures, 412–413
 - dissipation factor, 118
 - change with different stabilizer concentrations, 379
 - discharge effect, 399
 - ozone effect, 400
 - dissipation of surface charge, 444
 - effect of elongation on corona life, 396
 - effect of heating time on intrinsic viscosity, 413
 - effect of ion implantation on molecular weight, 403
 - electrical properties, 380
 - erosion, applied voltage and, 385, 387
 - ester formation, 418
 - intermolecular hydrogen abstraction, 415
 - IR spectra, 363
 - liquid droplets or bumps, 393–394
 - long chain branching, 416
 - low density
 - change in intrinsic viscosity when heated, 416–417
 - corona action versus ozone action, 396–398
 - microscopy, 370–371
 - multiple internal reflectance, 400–401
 - partial discharge, 381, 385
 - peroxide curing, 418
 - permittivity, 117, 399–400
 - photolysis, 329–330
 - radiolysis, 334
 - random initiation rate, 316–317
 - structure, 319

Polyethylene (*continued*)

- surface charge necessary for clinging, 449–450
- surface current versus voltage, 245
- surface resistivity, 228, 235
- test cell for exposure to corona and ozone, 398
- thermal and thermal-oxidative degradation, 319, 412–418
 - nitrogen atmosphere, 413
- treeing, 405–406
- water content, 373
- weight loss as function of temperature, 320

Polyimide

- frequency acceleration characteristics, 407
- thermal oxidation, 410

Polymer degradation, 340–377

- carbonyl absorbance as function of irradiation energy, 402
- chain depolymerization, 315–316
- charged particle bombardment
 - role in discharge degradation, 400–404
- chemical degradation mechanisms, 314–315
 - chemical polymer degradation, 336–338
 - corona degradation, 339
 - crosslinking, 314
 - mechanochemical degradation, 335–336
 - radiative degradation, 322–335
 - synergistic effects, 339–340
 - thermal degradation, 315–322
 - voltage aging, 338–339
- condensed-phase degradation products, 393–394
- corona-mechanical stress cracking, 394
- corona-stress cracking, 395

crystalline melting point, 350

density, 374

dynamic electrical behavior, 374–377

effect of ion implantation on molecular weight, 403

electrical degradation, 377–379

electron role in discharge degradation, 404

intrinsic viscosity as function of temperature, 336

IR absorption as function of charge, 401

microscopy, 370–372

molecular weight

- decrease with time under shear degradation, 335

- methods, 340–350

oxalic acid, 393

ozone role in discharge degradation, 395–400

spectroscopic techniques, 362–370

temperature dependence of modulus, 355

tensile strength, 373–374

thermal analysis, 350–356

thermal degradation, 382–383

volatiles analysis, 356–362

water analysis, 372–373

see also Partial discharges; Thermal degradation, aging and,

Polymers

Cole-Cole plot, 377

conductivity proportional to dose rate of electron bombardment, 404

dissipation factor, 375

loss factors, 376

more than one phase, 378

permittivity, 375

power lost in capacitor, 375

thermal-oxidative stability, effect of metals, 422–426

traps, 33

- Polymethyl methacrylate
 average leaking current versus time, 304
 radiolysis products, 334-335
 surface charge necessary for clinging, 450
 surface resistivity, 234-235
- Polyolefin, gel permeation chromatography, 349-350
- Polypropylene
 dissipation factor as function of IR absorbance, 383
 GC chromatogram, 392
 isotactic, thermal-oxidative degradation, 423
 photolysis, 330-331
 structure, 319
 tertiary carbon structures, 421
 thermal degradation, 319
 thermal oxidative degradation, 422
 effect of transition metal chelates, 424-426
 weight loss as function of temperature, 320
- Polystyrene
 degradation by NO_2 , 337
 flashover voltage, 279
 surface resistivity, 235
 thin film specimen, 197-198
- Polytetrafluoroethylene
 contact angle of water, 223
 dielectric life, 395
 effect of elongation on corona life, 396
 leakage currents, 242-244, 246
 surface conductivity, 242
 surface current versus voltage, 245
 surface resistivity, 234-235
 thermal degradation, 321-322
 water adsorption, 242
- Polyurethane, dissipation factor change with exposure to water, 378
- Polyvinyl chloride
 dechlorination, 321
 frequency acceleration characteristics, 407
 mass spectrometry of pyrolysis products, 419
 photolysis, 331-332
 relation between weight loss and degradation time at different HCl contents, 421
 thermal and thermal-oxidative degradation, 319-321, 418-421
- Population, statistical definition, 491
- Post insulators, 261
- Power absorption coefficient, 151
- Power dissipation, a-c bridge, 200
- Power loss relationship, 537
- Probability density function, 498
- Probability of failure, 503
- Probe transducer, characteristics, 467, 469-470
- Proof tracking index, 284
- Propagation, 323
 constant, shorted coaxial line method, 129
 factor, complex, 60
- Proportionality constant
 dependence on total discharge energy, 389-390
 electrostatic charge, 445
 erosion-energy relation, 387
 MKSA system, 536
- Pulse breakdown tests, apparatus, 190-192
- Purple plague, 241
- Pyrolysis gas chromatography, 358, 420
- Pyrolysis products, 409
- Q**
- Q*-meter, 54
 with fluid displacement cell, 117

- Q*-meter method, 99–102
 - automated, 101–102
 - circuit, 100
 - dissipation factor, 101
 - Q*-value, 100
- Quality factor, 137–138
- Quartz glass, surface conductivity, 242–243

R

- Radiative degradation, polymers, 327–335
 - photolysis, 328–333
 - radiolysis, 333–335
- Radioactive fieldmeters, 454
- Radiolysis, polymers, 333–335
 - correlation between crosslinking and degradation with heats of polymerization, 333
 - PMMA, 334–335
 - polyethylene, 334
- Randomization, 519–521
- Random numbers, 520
- R-C bridge measurement techniques, 81–83
- Rectangular microwave cavity, 135–136
- Re-entrant cavity system, 135
- Reflection coefficient, 124
- Reflectometry, time domain. *See* Time domain reflectometry
- Relative humidity
 - charge decay half life and, 451
 - effect on dielectric life, 397
 - surface resistivity, 227–234
- Relaxation time, dipole orientation process, 37
- Resistance, volume, 28
- Resistive voltage divider network, 19
- Resonant cavity methods, 133–141
 - attenuation, 140
 - Bessel functions, 140
 - closed cavity system, 135
 - coaxial resonator system, 135
 - dissipation factor, 139
 - frequency
 - limit, 135
 - pulling, 137
 - half-power bandwidth of empty resonant cavity, 137
 - instantaneous field configurations, 134
 - microwave system, 137–138
 - open cavity resonator, 135, 139–140
 - optical cavity resonators, 143
 - optical resonator system, 135
 - permittivity, 139
 - phase constant, 140
 - quality factor, 137–138
 - rectangular microwave cavity, 135–136
 - re-entrant cavity system, 135
 - resonant cavity specimen holder, 136–137
 - resonant frequency, 135
 - sensitivity, 134–135
 - voltage standing wave ratio, 136
- Resonant rise method. *See Q*-meter method
- RLC meter, Gen Rad Type 1689
 - precision dibrige, 96–98
- Rogowski-Rengier profile, 162
- Rydberg constant, 540

S

- Sample, statistical definition, 491
- Sandwich French cell, indirect exposure to corona, 254
- Scanning electron microscopy, 371
- Schering bridge, 53, 82, 200–208
 - arrangements
 - parallel substitution measurements, 85–86

- substitution measurements, 84–85
- balance condition, 202
- balance relation, 83–84
- circuit, 83
- connection error, 86
- dissipation factor, 202, 204, 206–207, 209–210
- with driven active shield, 207–208
- elementary arrangement, 201
- General Radio Type 716C, 87
- with guard circuit, 206–207
- loss factor, 375
- modified, 74–75, 208–210
 - dissipation factor up to 10, 204–205
- Poleck-type universal capacitance and $\tan \delta$ bridge, 208–210
- RC-bridge arrangements, 202–203
- screen technique for balancing guard circuit, 207–208
- spark gaps, 201
- specimen capacitance, 86, 202–204, 207, 209–210
- with stray capacitances to ground, 206
- Tettex AG precision capacitance and $\tan \delta$ bridge, 210–211
- vibration galvanometers, 201–202
- Wagner's earth method, 206
- see also* Transformer ratio arm bridge
- Scintillation
 - current, 276
 - defined, 282
 - evolved gas under, 298; 301
 - high density, salt mist, 271
 - integrated current, 306, 308
 - occurrence, 305
 - range of voltage to produce, 290
- Self-generating voltmeter, 455
- Self-healing effects, 194
- Semi-confocal optical cavity resonator, 145–147
- 7th Power Law, 524
- Shorted coaxial line method, 129
- Short-time test, 175, 177
- Signal amplifier, 462
- Silica glass, flashover voltage, 277
- Silica-polytetrafluoroethylene, pyrolyzing, 411
- Silicon carbide coatings, 260
- Silicone fluids, fluid displacement cell, 117
- Silicone glass laminate, surface resistivity, 231–232
- Silli-Putty, 354
- Silver migration, surface, 241
- Silver paint, high conductivity, 12
- SI system, 532, 539–540
 - conversion factors with Gaussian CGS system, 541–542
 - derived units, 540
 - prefixes, 540
- Size-exclusion chromatography, polymer degradation, 347–350
- Slow-rate-of-rise test, 175–176, 181
- Soil resistivity, 48
- Solid-state high frequency inverter, schematic, 465
- Solvent etching, 371
- Space charge, 17
- Spacers, 261–262
- Spark gaps, 201
- Specific breakdown field, 199
- Specific inductive capacity. *See* Permittivity
- Specimen, statistical definition, 491
- Spectroscopic techniques, polymer degradation, 362–370
 - electron spin resonance, 364–367
 - infrared, 362–364
 - nuclear magnetic resonance, 367–370
- Spherulites, 378

- Square voltage pulse, 72–73
- Standard deviation, 494
 - definition, 495
 - logarithmic, 500
- Statistical methods for evaluation
 - comparative tests, 513, 516–521
 - confidence bounds, 508–513
 - elementary principles, 491–494
 - experimental designs, 521–522
 - histogram, dielectric strength data, 492
 - history, 490
 - life prediction techniques, 522–527
 - purposes, 490–491
 - scatter, 491
 - types of distribution and uses, 492–493
 - see also* specific types of distribution
- Step-by-step test, 175–176, 181–182
- Step response system, 68
 - characteristic, 3% carbon black filled polyethylene, 70
 - charging current, 70
 - control unit timing sequence, 69–70
 - discharging current, Fourier transformation, 71
- Stress parameter, 502
- Student's *t*-test, 513, 516–517
- Submillimeter wave methods, 147
- Sulfur dioxide, polymer degradation, 337–338
- Sulfur hexafluoride, contaminated, variation in composition, exposure to arc discharge, 390–391
- Superposed voltage tests, apparatus, 191–194
 - a-c, 192
 - a-c/d-c, 192
 - additive and subtractive impulses on d-c bias level, 194
 - d-c, 191–193
 - impulse on d-c tests, 193
- Surface
 - adsorption of water vapor, 241
 - balance of surface energies, 222
 - charges, 252–253
 - cleaning, 225
 - conductivity, 242–243
 - contact angle, 22
 - contaminants, 222
 - corona, 221, 253–255, 260
 - defined, 221
 - wetting tension, 223
- Surface current-voltage curves, 245
- Surface discharge, 255–256, 379–382
 - degradation from, 254
 - electrode geometry, 255
 - elimination, 260
 - oil-impregnated paper or press-board, 256–257
 - patterns, 255
- Surface failure measurements
 - biological surface contamination, 234–240
 - contaminant, 224
 - distribution of moisture across dimension perpendicular to faces exposed, 230–231
 - dry surface flashover and dry tracking, 248–268
 - dry arc resistance, 263–268
 - failure under arcing, 262–263
 - influence of pressure and vacuum, 251–252
 - spacers, 261–262
 - surface corona, 253–255
 - surface discharge, 255–256
 - theoretical considerations of surface charges, 252–253
 - tracking, 256–261
 - see also* Flashover voltage
 - electrolytic corrosion and silver migration, 240–241

- fungicide, 234–235
 - imperfections, 221
 - insulation resistance, surface resistance, and surface resistivity, 225–227
 - interfacial failure, 221
 - oily coating, 223
 - purple plague, 241
 - space-charge controlled current-voltage relationship, 246
 - surface resistivity, high relative humidity, 227–234
 - theoretical considerations, 241–247
 - total enclosure, 225
 - variation of conduction current with time, 246
 - wet contaminated surfaces, 268–309
 - creepage distance, 269
 - erosion drop test, 282–286
 - erosion tests. *See* Erosion tests
 - tracking, 282–286
 - weathering and contamination of insulation surfaces, 269–270
 - see also* Flashover; Surface resistance; Surface resistivity
 - Surface resistance
 - engineering significance, 247–248
 - hook-up wire, 236, 238–239
 - measurement, 226–227
 - plastic insulated wire, 236–237
 - Surface resistivity
 - effect of contamination, 234–235
 - high relative humidity, 227–234
 - glass after 1 day at 23°C, 244
 - glass as temperature is reduced, 228–229
 - interfacial resistance, 232–233
 - materials that absorb relatively large amounts of water, 230
 - polarization, 227
 - polyethylene, 228, 235
 - versus time, 228–230
 - influence of glass composition, 243–244
 - measurement, 226–227
 - oil-modified, phenolic varnish coated on solid glass, 239
 - polymethyl methacrylate, 234–235
 - polystyrene, 235
 - polytetrafluoroethylene, 234–235
 - Surface tracking, 174
 - Susceptance variation method, 102–108
 - capacitance, 103–106
 - dissipation factor, 107
 - edge correction, 106
 - equivalent shunt conductance, 104
 - modified circuit, 106
 - potential difference, 103
 - resonance curve, 105
 - resonator, 107–108
 - simplified equivalent circuit, 102–103
 - Synergistic effects, polymers, 339–340
 - Systems of units
 - CGS electromagnetic system, 531
 - CGS electrostatic system, 531
 - conversions between, 539–541
 - electrical units, 531–533
 - Gaussian CGS system, 532–536
 - history, 530–531
 - MKSA system, 532, 536–539
 - rationalized, 533
 - SI system, 532, 539–540
 - units and equivalents, 543–544
 - unrationalized, 533
- T**
- Teflon
 - flashover voltage, 277
 - peak scintillation current, 276

- Teflon (*continued*)
 surface conductivity, 242–243
 surface current-voltage curves, 245
- Tensile strength, polymers, 373–374
- Test chamber, 174–175
- Tetramethylsilane, NMR chemical shifts, 368
- Tettex AG precision capacitance and $\tan \delta$ bridge, 210–211
- Theovibron dynamic viscoelastometer, 355–356
- Thermal analysis, polymer degradation, 350–356
 differential, 350–353
 differential scanning calorimetry, 353
 dynamic mechanical analysis, 354–356
 glass transition temperature, 350–351
 thermogravimetric analysis, 353–354
- Thermal conductivity detector, gas chromatography, 358
- Thermal degradation, 382–383
 epoxy resins, 421–422
- Thermal degradation
 aging and, 408–426
 Dakin's equation for life of insulation, 408
 differential scanning calorimetry, 411
 differential thermal analysis, 411–412
 polyethylene, 412
 polyvinyl chloride, 418
 thermal oxidative degradation. *See* Thermal oxidative degradation
 thermogravimetric analysis, 411–412
 volatiles analysis, 408–411
 polymers, 315–322
 chain depolymerization, 315–316
 degree of polymerization as function of time, 318
 depropagation, 317–318
 kinetics, 315–319
 polyethylene, 319
 polypropylene, 319
 polytetrafluoroethylene, 321–322
 polyvinyl chloride, 319
 random initiation rate, 316–317
 products, 409
- Thermally stimulated current measurements, 33–45
 characterizing origin of charge traps, 33
 current density behavior resulting from dipole movements, 37
 densities of conduction and trapped electrons, 34
 dipole orientation, 36–37
 fast electron retrapping case, 34–35
 general form of curve, 36
 high electric field, 35–36
 photostimulated detrapping current techniques, 41
 relaxation time, dipole orientation process, 37
 sequence with and without x-ray irradiation, 40
 slow electron retrapping case, 35
 test thickness for polymers, 42–44
 thermoluminescence
 intensity, 38
 measurements, 37
 X-ray induced, 38–40
- Thermal optical analysis, polymer degradation, 371–372
- Thermal oxidative degradation, 383, 410
 polyethylene, 412–418

- polypropylene, effect of transition metal chelates, 424–426
- polyvinyl chloride, 418–421
- Thermal-oxidative stability, polymers, effect of metals, 422–426
- Thermal stress, causes, 408
- Thermogravimetric analysis, 388, 411–412
 - derivative, polyvinyl chloride, 420
 - polymer degradation, 353–354
- Thermoluminescence
 - intensity, 38–40
 - measurements, 37
- Thin films, breakdown strength measurements, 194–200
 - alumina film specimen preparation, 197–198
 - apparatus, 195
 - circuit analysis and statistical treatment, 198–199
 - electrometer arrangement, 196
 - film thickness, 197
 - inorganic films, 196
 - non-destructive breakdowns preceding non-reversible breakdown, 195
 - self-healing effects, 194
 - specific breakdown field, 199
 - time lag, 197, 199
- Thompson-Harris low frequency bridge, 54, 75–79
 - balance equations, 77–78
 - current node equations, 77
 - equivalent circuit, 76
 - measurement range, 78
 - modified version, 79–80
 - schematic circuit diagram, 76
 - with zero adjustment feature, 78–79
- Time domain reflectometry, 123–126
 - dual channel configuration, 127–128
 - idealized trace, voltage step pulse, 125
 - long-time horizontal drift, 127
 - low frequency limit, 126
 - permittivity, 124–125
 - reflection coefficient, 124
 - sensitivity, 128
 - specimen thickness, 127
 - system, 123–124
- Time lag, 197, 199
- Time parameter, 503
- Tin foil electrode, 12
- Total reflection coefficient, 127
- Tracking, 256–261
 - arcing problem, 260
 - arc tracking rate test, 267
 - coatings with non-linear resistance characteristic with voltage, 260
 - comparative tracking index, 283–284
 - contamination, defined, 282
 - d-c, 285–286
 - defined, 282
 - differential wet, 288
 - dust-and-fog, 287–288
 - geometry producing high voltage gradient, 258
 - inclined-plane test
 - erosion depth and volume, 295
 - evolved gas under scintillation, 298, 301
 - failures, 292
 - influence of variables, 299–300
 - liquid-contaminant, 288
 - range of voltage to produce scintillation, 290
 - sugar added to ammonium chloride contaminant, 296, 299
 - values, 293
 - initial voltage, 288
 - contaminant influence, 296

Tracking (*continued*)

- lateral failure, 257–258
 - low d-c voltages, 286
 - resistance to, 263
 - severe ambient conditions, 288–289
 - solids immersed in insulating oil, 256–257
 - time-to-track, 288
 - voltage
 - different gas ambients, 296, 300
 - distribution along surface, 259
 - versus number of contaminant droplets, 284
 - versus resistivity of contaminant, 290–291
 - voltage test, 288
 - wet contaminated, 282–286
- Transformer ratio arm bridge, 88–89, 211–216
- balance condition, 89
 - balance equation, 93, 213
 - balancing, 89–90
 - capacitance, 213
 - shunting, 94
 - dissipation factor, 93, 212–213, 215
 - errors, 91–92, 212
 - features, 94
 - frequency range, 94
 - Gen Rad Type 1621, 90–93
 - in-phase current component, 214–215
 - modified, 211
 - NRC/Guideline current comparator bridge, 214–215
 - schematic, 213
 - three-terminal connection, 91
- Transient voltages, 178
- Transition metal chelates
- effect on oxidative thermal degradation of polypropylene, 424–426
 - structure, 425

Transmission line method

- dielectric constant, 133
 - dissipation factor, 133
 - impedance at specimen-air interface, 130
 - load impedance, 130–131
 - phase constant, 130
 - phase distance, 132
 - propagation constant, 129
 - radiation wavelength in free space, 129
 - schematic diagram, 131
 - shorted coaxial line, 129
 - specimen holder, 132
 - standing wave pattern, 129, 131
 - voltage standing wave ratio, 130
- Transmittance IR, 363
- Treeing, 338–339, 372
- free radical chemistry, 405
 - frequency and, 407
 - partial discharges, 405
- Triboelectric series, 441–442
- Triboelectrification, 441
- t*-test, 513, 516–517
- Tunnelling, electrostatic charge, 444
- t*-values, 508

U

- Unshielded wires and cables, water-electrode-bath system, 7

V

- van't Hoff's law, 343
- Vapor phase osmometry, 341–342
- Variance, 495–496
- Vented trees, 339
- Vibrating capacitance system, 45
- Vibrating capacitor modulator, 461
- Vibrating vane modulator, 461–462
- Vibration galvanometers, 201–202
- Vinyl hydroperoxides, 393
- Virtual-front time, 179
 - impulse generators, 185

- Viscoelasticity, 354
 Viscometer, 346–347
 Viscosity, 346–347
 intrinsic, 347
 change when heated, 416–417
 effect of heating time, 413
 as function of temperature, 336
 Viscosity-average molecular weight, 340
 Volatiles analysis, polymer degradation, 356–362, 408–411
 gas chromatography, 356–358
 gas chromatography-mass spectrometry, 361
 high performance liquid chromatography, 361–362
 mass spectrometry, 359–360
 Voltage
 aging, polymers, 338–339
 incident pulse, Fourier transform, 126
 reflection pulse, Fourier transform, 126
 square pulse, 72–73
 standing wave ratio, 130, 136
 step, 122–123
 Voltage breakdown
 defined, 176
 direct, 177
 histogram, 492
 Voltage breakdown tests, 157–200
 history, 157–158
 immersion fluids, 159
 intrinsic breakdown strength, 160–161, 165–172
 a-c breakdown tests, 175–177
 corona discharges, 162–164
 d-c breakdown tests, 177–178
 defects, 173
 definition, 161–162
 dielectric failure, defined, 176
 electrode considerations, 174
 impulse breakdown tests, 178–179
 impulse strength, 173–174
 measurements, 161–165
 metallic evaporated films, 163
 pulsed voltage conditions, 180
 short time test, 175, 177
 slow-rate-of-rise test, 175–176
 space charge effect hypothesis, 173–174
 specimen thickness, 173
 step-by-step test, 175–176
 surface tracking, 174
 temperature effects, 173
 test apparatus, 180–193
 test chamber, 174–175
 testing procedures, 172–180
 thin films, 194–200
 transient voltages, 178
 virtual-front line, 179
 voltage application rate, 173
 voltage source, inadvertent tripping, 177
 see also Electrode system
 permittivity real value, 159
 recessed electrode system, 160
 with spherical HV electrode, 162–164
 Voltage-life-curve, 525
 Voltage rate-of-change method, 25–27
 Voltmeter-ammeter method
 with calibrated potentiometer, 23–25
 with d-c amplification, 23–24
 comparison method, 27–28
 Volume discharges, 379–382

W

- Wagner's earth method, 82–83, 206
 Water analysis, polymer degradation, 372–373
 Water-electrode-bath system, direct-current conductivity, 7
 Water tree, 338–339

- Waveguides, electromagnetic wave propagation modes, 61–62
- Weibull distribution, 492–493, 501–508
 - analytical determination of parameters, 507–508
 - commercial paper, 505–507
 - comparative tests, 517
 - 95% confidence bounds, 514, 516
 - 80% confidence intervals, 515, 519
 - definition, 502
 - different scale parameters with same shape parameter, 502
 - different shape parameters with same scale parameter, 503
 - failure rate versus time, 504
 - graphic determination of parameters, 505–507
 - relation to inverse power model, 525
 - small beta estimator, 507
 - stress parameter, 507
 - stress plot, 502–503
 - time plot, 502–504
 - voltage-life plot of time-to-failure data, 525
 - V-values, 511–512
 - W-values, 512
- Weight-average molecular weight, polymer degradation, 343–345
 - equation, 340
 - light scattering, 343–345
- Wetting tension, 223
- Wheatstone bridge method, 28–30
- Wien bridge, 53

X

- X-ray induced thermally stimulated current, 38–40